晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AM-1280800WVTZQW-T83H
APPROVED BY	
DATE	

☐ Preliminary Specification
■ Formal Specification

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Approved by	Checked by	Organized by
Patrick	Kokai	Mark

*This specification is subject to change without notice.

RECORD OF REVISION

Revision Date	Page	Contents	Editor
2022/04/25	--	New Release	Mark

1.0 General Descriptions

1.1 Introduction

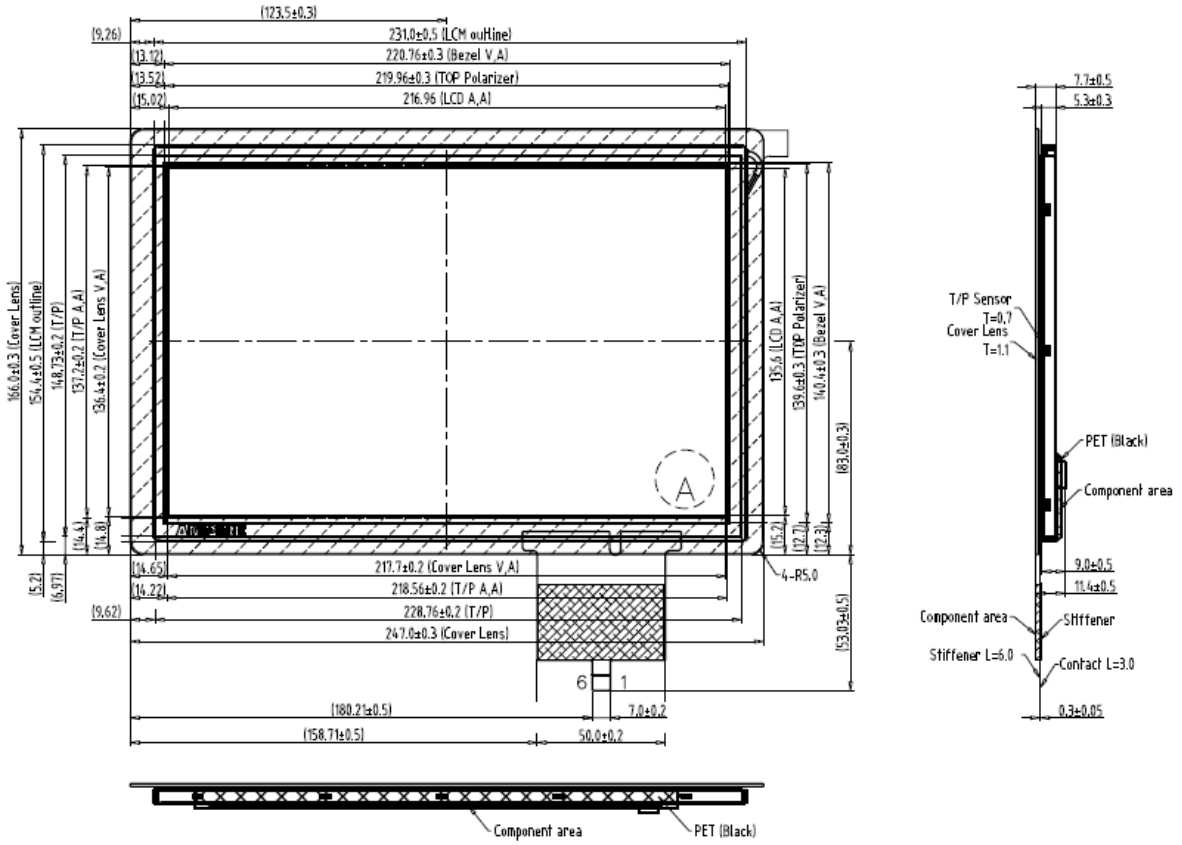
The LCM is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. It is composed of a TFT LCD panel, a backlight system, column driver and row driver circuit. This TFT LCD has a 10.1-inch diagonally measured active display area with WXGA resolution (1280 horizontal by 800 vertical pixels array).

1.2 Features

- 10.1” TFT LCD Panel
- LED Backlight System
- Supported WXGA 1280x800 pixels resolution
- Compatible with RoHS Standard
- Build in LED Driver
- Touch Panel:
  - Controller: ILI2511
  - Interface: I2C
  - Cover Glass: T=1.0mm, black frame.

1.3 Product Summary

Items	Specifications	Unit
Screen Diagonal	10.1	Inch
Active Area	216.96(H) x 135.6(V)	mm
Pixel Format	1280(RGB) x800	-
Pixel Pitch	0.1695(H) x 0.1695 (V)	mm
Pixel Arrangement	R.G.B. Vertical Stripe	-
Display Mode	Normally Black	-
White Luminance	850 (Typ.)	cd /m2
Contrast Ratio	800 : 1 (Typ.)	-
Response Time	25	msec
Input Voltage	3.3	V
Electrical Interface (Logic)	LVDS	-
Support Color	16.7M	-



2.0 Absolute Maximum Ratings

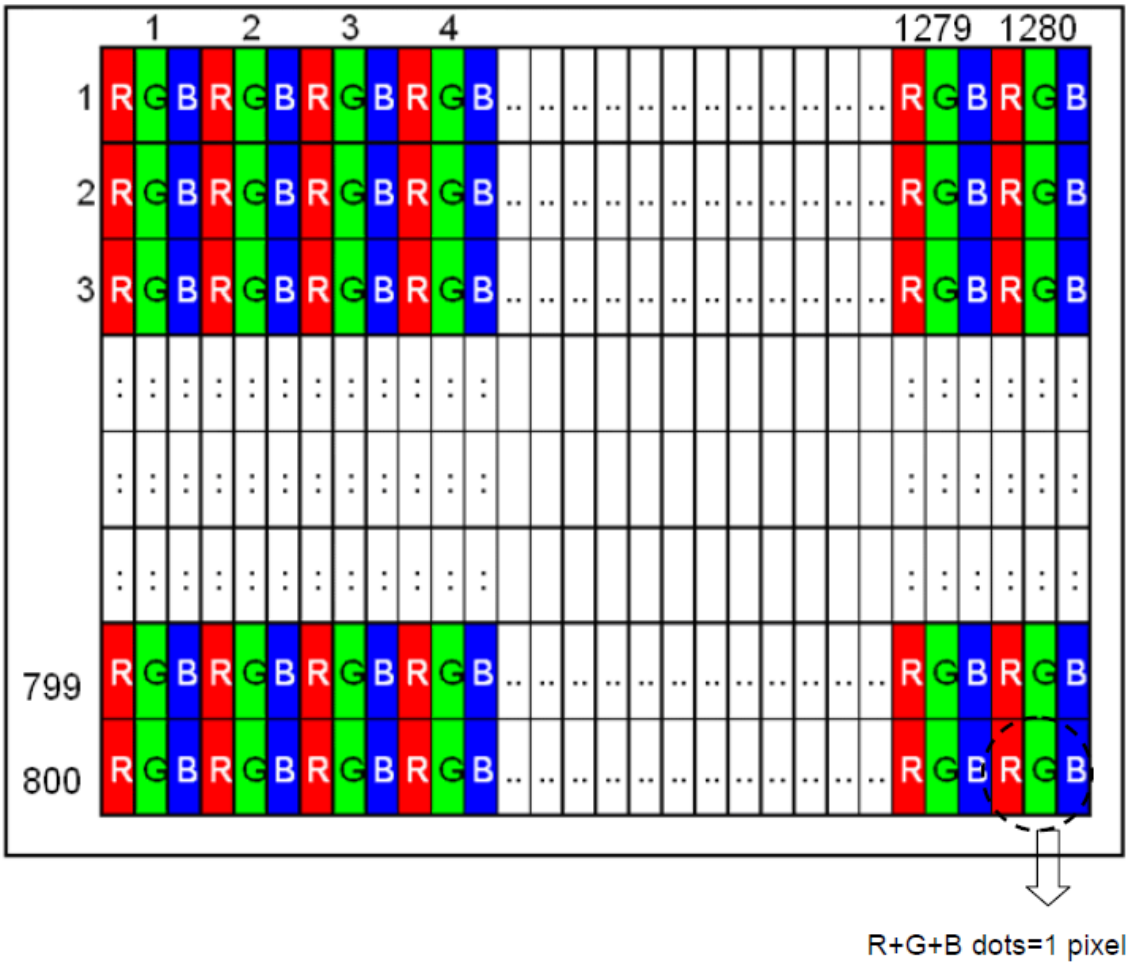
ITEM	SYMBOL	VALUES		UNIT	REMARK
		MIN	MAX		
Power Voltage	V_{DD}	-0.3	4.0	V	VSS=0V, TA=25℃
	V_{LED}	-0.3	24	V	
Operation Temperature	T_{op}	-20	70	℃	
Storage Temperature	T_{st}	-30	80	℃	

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

3.0 Pixel Format Image

Figure 2 shows the relationship of the input signals and LCD pixel format image.

Figure 2 Pixel Format



4.0 Optical Characteristics

The optical characteristics are measured under stable conditions as following notes

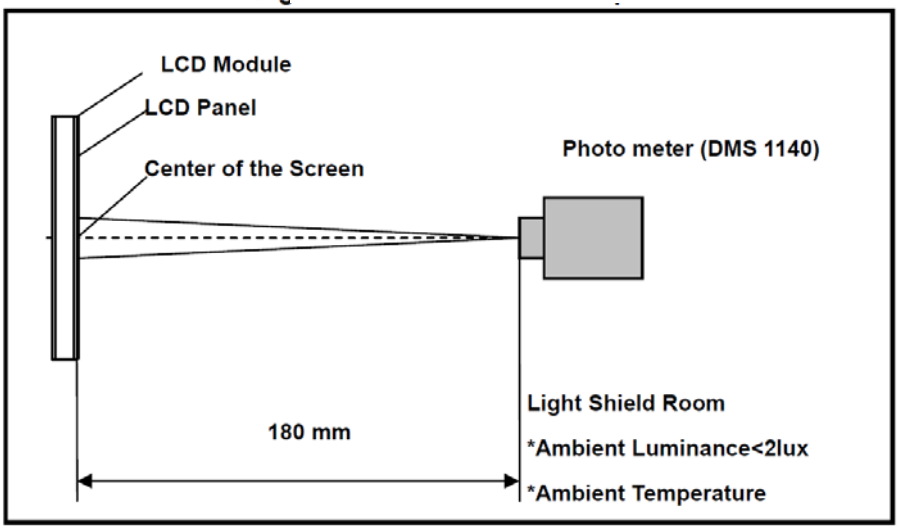
Table 2 Optical Characteristics

Item	Conditions		Min.	Typ.	Max.	Unit	Note
Viewing Angle （CR>10）	Horizontal	θ L	(75)	(85)	-	degree	(1),(2),(3)
		θ R	(75)	(85)	-		
	Vertical	θT	(75)	(85)	-		
		θ B	(75)	(85)	-		
Contrast Ratio	Center		(600)	(800)	-	-	(1),(2),(4)
Response Time	Rising		-	-	-	ms	(1),(2),(5)
	Falling		-	-	-	ms	
	Rising + Falling		-	25	-	ms	
Color Chromaticity (CIE1931)	NTSC		-	45	-	%	(1),(2)
	Red	x	Typ. -0.05	0.561	Typ. +0.05	-	(1),(2)
	Red	y		0.334		-	
	Green	x		0.341		-	
	Green	y		0.568		-	
	Blue	x		0.161		-	
	Blue	y		0.129		-	
	White	x		0.313		-	
	White	y		0.329		-	
White Luminance	Center		680	850	-	cd/m^2	(1),(2),(6)
Luminance Uniformity	9Points		70	75	-	%	(1),(2),(6)

Note(1) Measurement Setup:

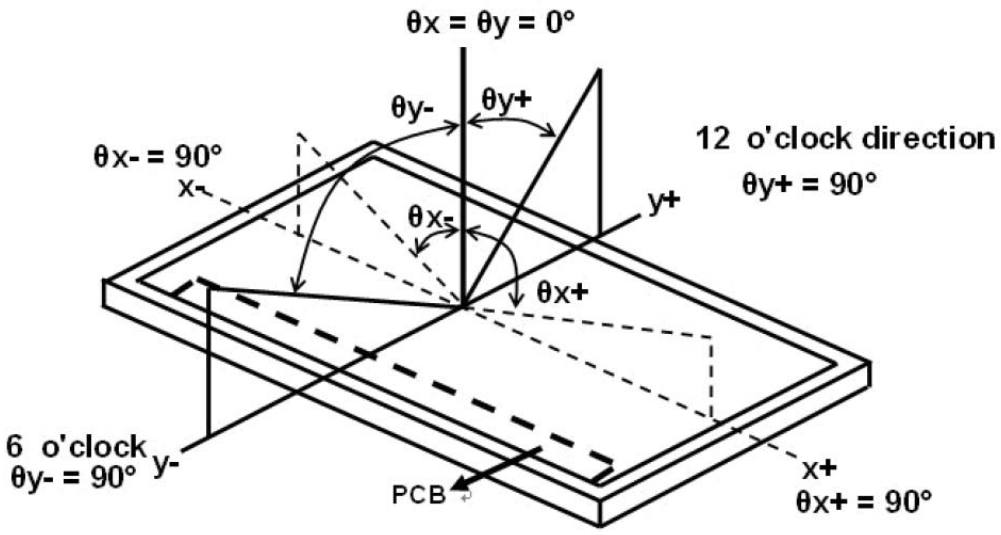
The LCD module should be stabilized at given temperature(25℃) for 15 minutes to Avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.

Fig



Note(2) The LED input parameter setting as: PWM: duty 100 %

Note(3) Definition of viewing angle:



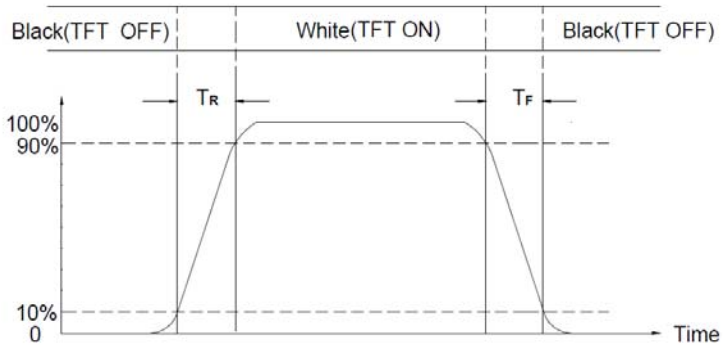
Note(4) Definition of Contrast Ratio (CR)

The contrast ratio can be calculated by the following expression

Contrast Ratio (CR) = L255 / L0

L63: Luminance of gray level 255, L0: Luminance of gray level 0

Note(5) Definition of Response Time (TR, TF)



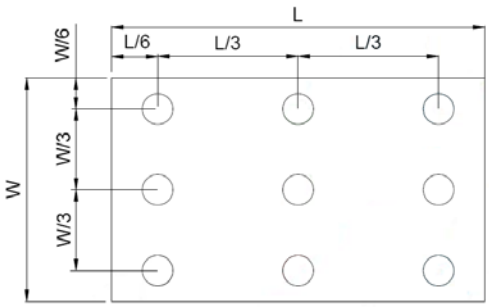
Note(6) Definition of brightness luminance

Active area is divided into 9 measuring areas (Refer to bellow figure).

Every measuring point is placed at the center of each measuring area.

$$\text{Luminance Uniformity (Yu)} = \frac{B_{min}}{B_{max}}$$

L ----- Active area length W ----- Active area width



Bmax: The measured maximum luminance of all measurement position.

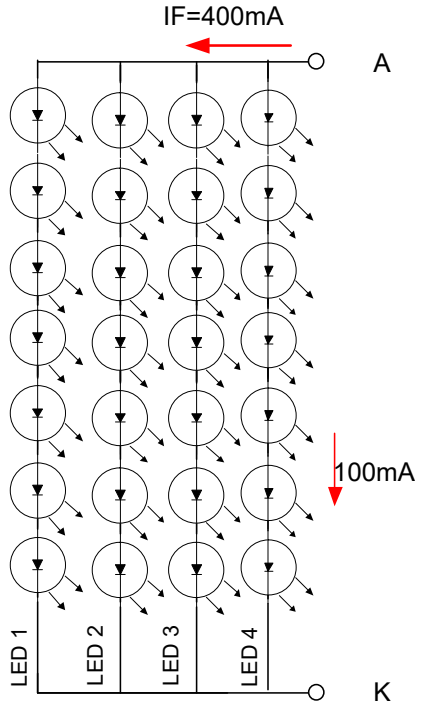
Bmin: The measured minimum luminance of all measurement position.

5.0 Backlight Characteristics

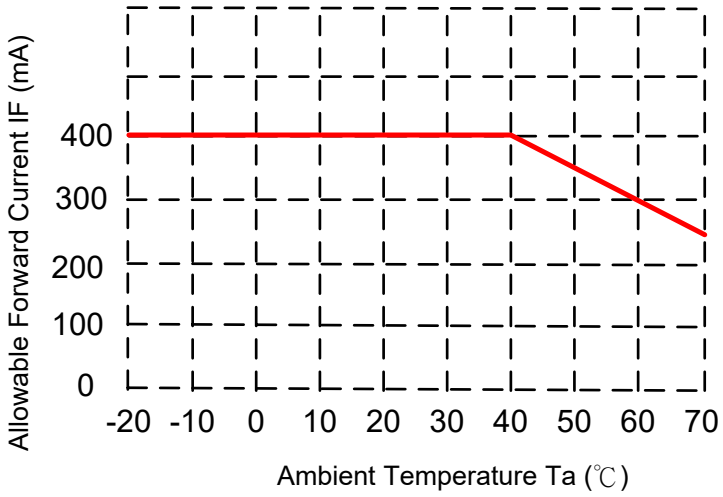
ITEM	SYMBOL	MIN	TYP	MAX	UNIT	CONDITION
LED Backlight Voltage	V_{BL}	--	21	23.1	V	For reference
LED Backlight Current	I_{BL}	-	400	--	mA	**Ta=25℃**
LED Life Time		--	50K	-	KHr	Note*

Note* : Brightness to be decreased to 50% of the initial value.

Ta=25℃



When LCM is operated over 40℃ ambient temperature, the ILED should be follow :



6.0 Electrical Characteristics

6.1 TFT LCD Module Interface Connector

Table 4 Connector Name / Designation

Item	Description
Manufacturer / Part Number	Starconn / 300E40-0010RA-G3
Mating Model Number	TBD or compatible

Table 5 Signal Pin Assignment

Pin #	Signal Name	Description	Remarks
1	NC	Not Connect	-
2	VDD	Power Supply, 3.3V (typical)	-
3	VDD	Power Supply, 3.3V (typical)	
4	VDD_EDID	Power Supply for EDID I2C Flash IC	
5	SCL_EDID	I2C Serial Clock for EDID I2C Flash IC	
6	SDA_EDID	I2C Serial Data for EDID I2C Flash IC	
7	NC	Not Connect	
8	LV0N	-LVDS differential data input	
9	LV0P	+LVDS differential data input	
10	GND	Ground	
11	LV1N	-LVDS differential data input	
12	LV1P	+LVDS differential data input	
13	GND	Ground	
14	LV2N	-LVDS differential data input	
15	LV2P	+LVDS differential data input	
16	GND	Ground	
17	LVCLKN	-LVDS differential data input	
18	LVCLKP	+LVDS differential data input	
19	GND	Ground	
20	LV3N	-LVDS differential data input	
21	LV3P	+LVDS differential data input	
22	GND	Ground	
23	LED_GND	Ground for LED Driving	
24	LED_GND	Ground for LED Driving	
25	LED_GND	Ground for LED Driving	
26	NC	Not Connect	
27	LED_PWM	PWM Input signal for LED driver :3.3V	
28	LED_EN	LED Enable Pin :3.3V	
29	NC	Not Connect	
30	NC	Not Connect	
31	LED_VCC	Power Supply for LED Driver :12V	
32	LED_VCC	Power Supply for LED Driver :12V	
33	LED_VCC	Power Supply for LED Driver :12V	
34	NC	Not Connect	
35	BIST	BIST pin. (Keep NC or **High** if not use.)	
36	CSB	Serial communication enables. (For test only)	
37	SCL	Serial communication clock input (For test only)	
38	SDA	Serial communication data input. (For test only)	
39	SCL_I2C	Serial communication clock input. (For test only)	
40	SDA_I2C	Serial communication data input. (For test only)	

Note: All input signals shall be low or Hi-resistance state when VDD is off.

6.2 LVDS Receiver

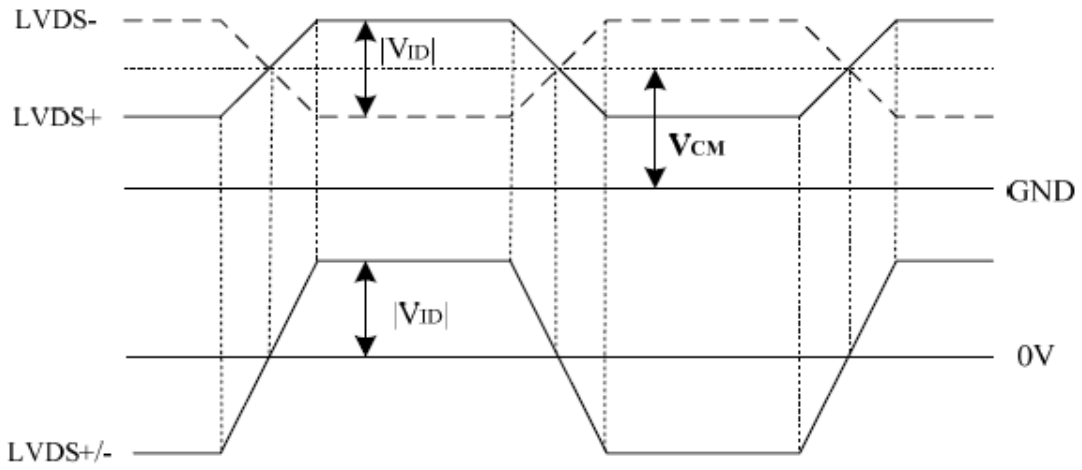
6.2.1 Signal Electrical Characteristics For LVDS Receiver

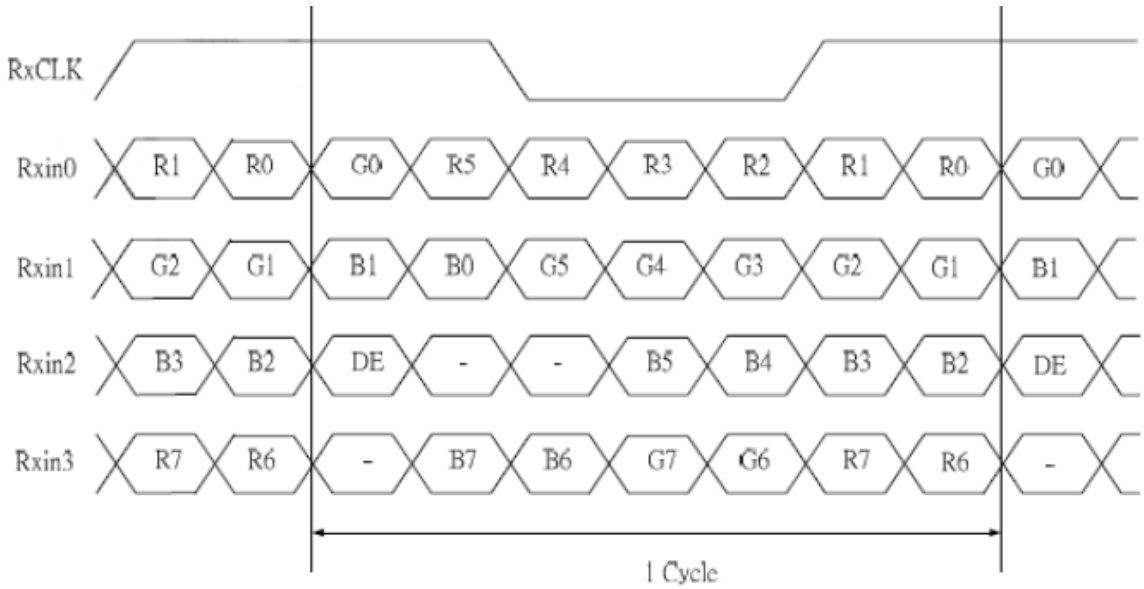
Table 7 LVDS Receiver Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Differential Input High	Vth	-	-	+100	mV	V_{CM}=+1.2V
Differential Input Low	Vtl	-100	-	-	mV	V_{CM}=+1.2V
Magnitude Differential Input	$\|V_{ID}\|$	200	-	400	mV	-
Common Mode Voltage	V_{CM}	0.3+(VID/2)	-	VDD-1.2-(VID/2)	V	-
Common Mode Voltage	ΔV_{CM}	-	-	50	mV	V_{CM}=+1.2V

Note (1) Input signals shall be low or Hi-Z state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.





7.0 Interface Timings

7.1 Timing Characteristics

Interface Timings

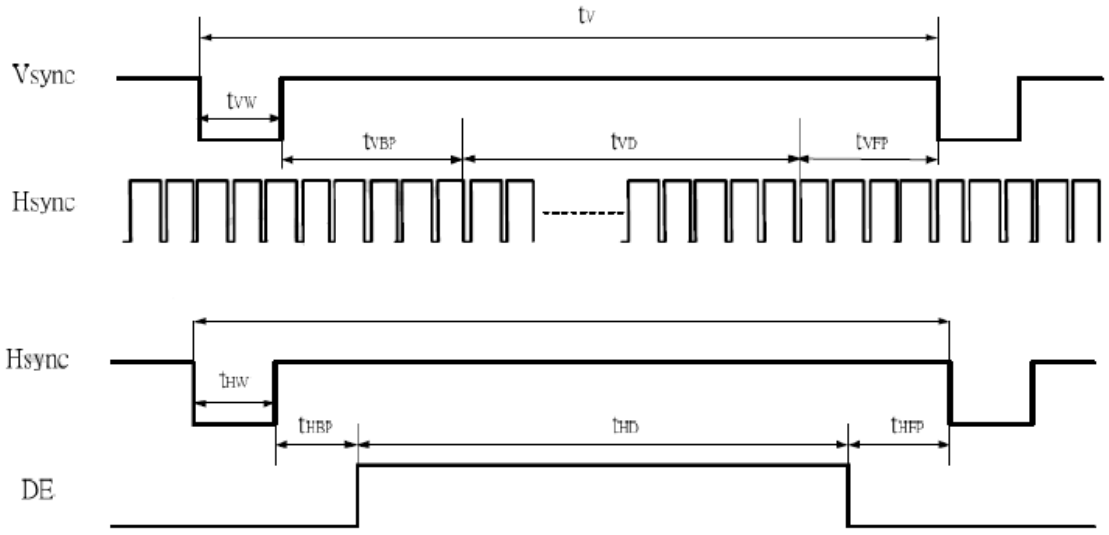
Parameter	Symbol	Min.	Typ.	Max.	Unit
LVDS Clock Frequency	Fclk	(70.0)	(72.4)	(76.6)	MHz
H Total Time	HT	(1,410)	(1,440)	(1,470)	Clocks
H Active Time	HA		1,280		Clocks
V Total Time	VT	(828)	(838)	(868)	Lines
V Active Time	VA		800		Lines
Frame Rate	FV	-	(60)	-	Hz

Note1： HT * VT *Frame Frequency≤(76.6) MHz

Note2: All reliabilities are specified for timing specification based on refresh rate of 60Hz.

7.2 Timing Diagram of Interface Signal (DE mode)

Figure 8 Timing Characteristics



8.0 Power Consumption

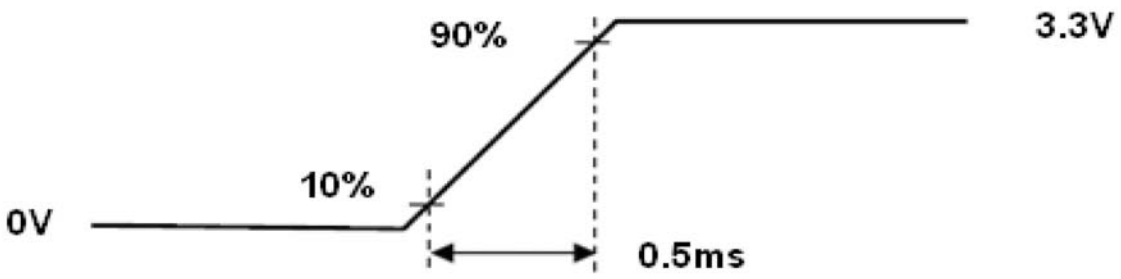
Input power specifications are as follows.

Table 8 Power Consumption

Item		Symbol	Min	Typ.	Max	Unit	Note
LCD Drive Voltage		VDD	3.0	3.3	3.6	V	(2),(4)
VDD Current	White Pattern	IDD	--	0.27	--	A	(3),(4)
VDD Power Consumption	White Pattern	PDD	--	--	1.0	W	(3),(4)
Rush Current		Irush			1.5	A	(1),(4),(5)
Allowable Logic/LCD Drive Ripple Voltage		VDDrp			300	mV	(4)
LED Driver Power Voltage		VLED	--	12	--	V	
LED Driver Current		ILED	--	0.75	--	A	LED_EN =ADJ=High
ADJ frequency		f_{PWM}	100	--	20k	Hz	
ADJ logic level High		VIH	2.4	--	--	V	
ADJ logic level High		VIL	--	--	0.7	V	

Note (1) Measure Condition

Figure 9 VDD rising time

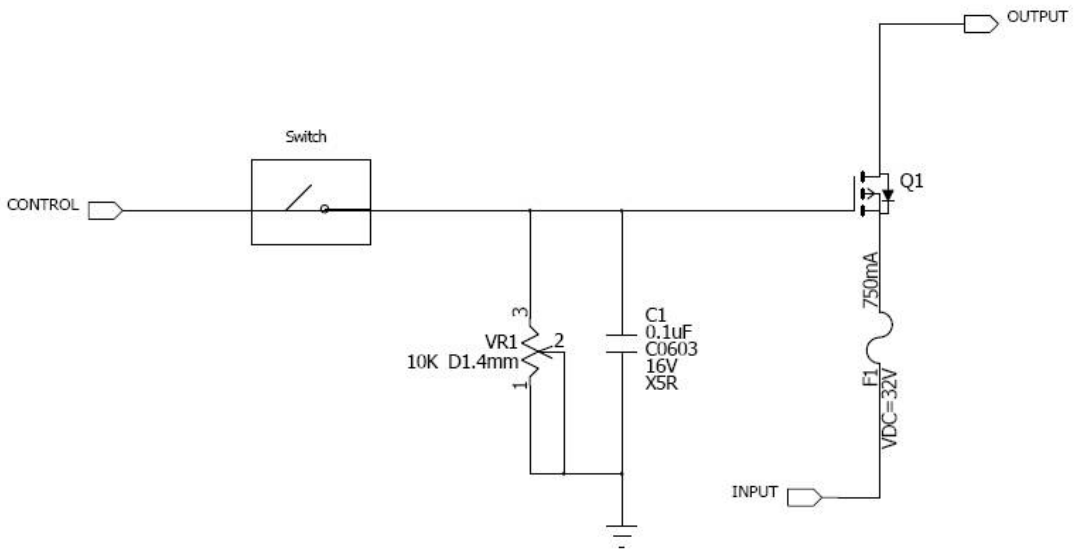


VDD rising time

Note (2) Frame Rate=60Hz, VDD=3.3V,DC Current.

Note (3) Operating temperature 25℃ , humidity 55%RH.

Note (4) The reference measurement circuit of rush current.



9.0 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.

Figure 11 Power Sequence

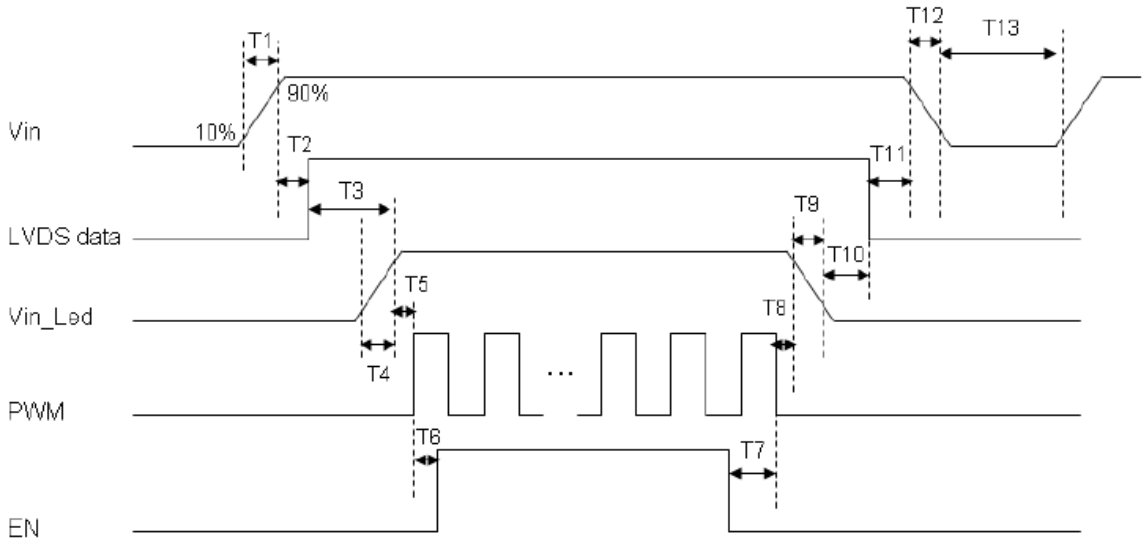


Table 9 Power Sequencing Requirements

Parameter	Symbol	Unit	Min	Typ.	Max
VIN Rise Time	T1	ms	0.5	--	10
VIN Good to Signal Valid	T2	ms	30	--	90
Signal Valid to Backlight On	T3	ms	200	--	--
Backlight Power On Time	T4	ms	0.5	--	--
Backlight VDD Good to System PWM On	T5	ms	10	--	--
System PWM ON to Backlight Enable ON	T6	ms	10	--	--
Backlight Enable Off to System PWM Off	T7	ms	0	--	--
System PWM Off to B/L Power Disable	T8	ms	10	--	--
Backlight Power Off Time	T9	ms	--	10	30
Backlight Off to Signal Disable	T10	ms	200	--	--
Signal Disable to Power Down	T11	ms	0	--	50
VIN Fall Time	T12	ms	--	10	30
Power Off	T13	ms	500	--	--

10.0 Projected capacitive-type Touch panel specification
Basic Characteristic

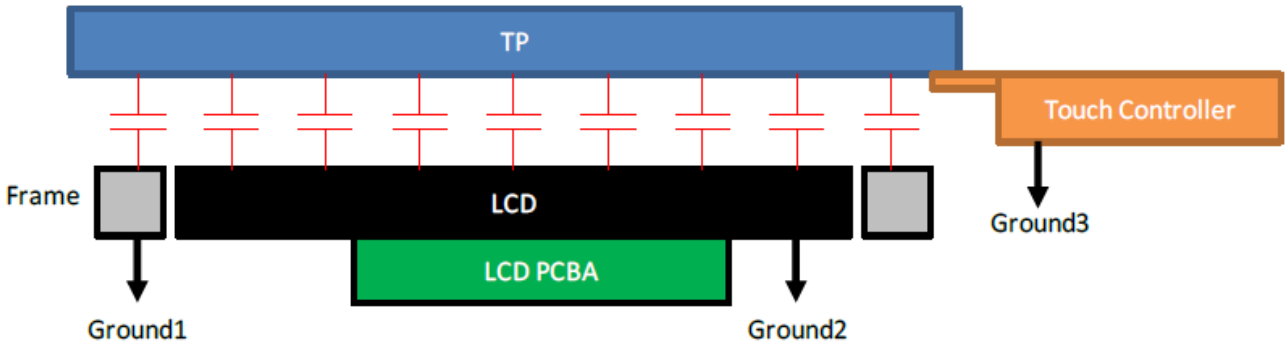
ITEM	SPECIFICATION
Type	Projective Capacitive Touch Panel
Activation	Max 10-fingers or Signal-finger
X/Y Position Reporting	Absolute Position
Touch Force	No contact pressure required
Calibration	No need for calibration
Report Rate	Approx 80 points/sec
Interface	I2C
Control IC	ILI2511

Item	Symbol	Min.	Typ.	Max.	Unit
Power Supply Voltage	VIN	3.14	3.3	3.46	V
Low Level Input Voltage	VIL	0	--	0.3*VIN	V
High Level Input Voltage	VIH	0.6*VIN	--	VIN	V

10.2 Interface

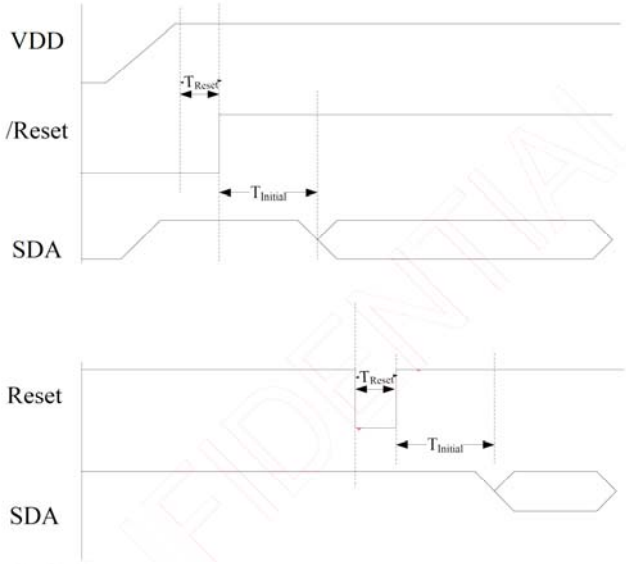
Pin No.	Symbol	Function
1	VIN	Power Supply for TP controller
2	SCL	I2C Data
3	SDA	I2C Clock
4	INT	Interrupt Request pin
5	RES	Rest pin to Master Chip
6	GND	GND

TP needs to work in environment with stable stray capacitance. In order to minimize the variation in stray capacitance, all conductive mechanical parts must not be floating. Intermittent floating any conductive part around the touch sensor may cause significant stray capacitance change and abnormal touch function. It is recommended to keep all conductive parts having same electrical potential as the GND of the touch controller module.



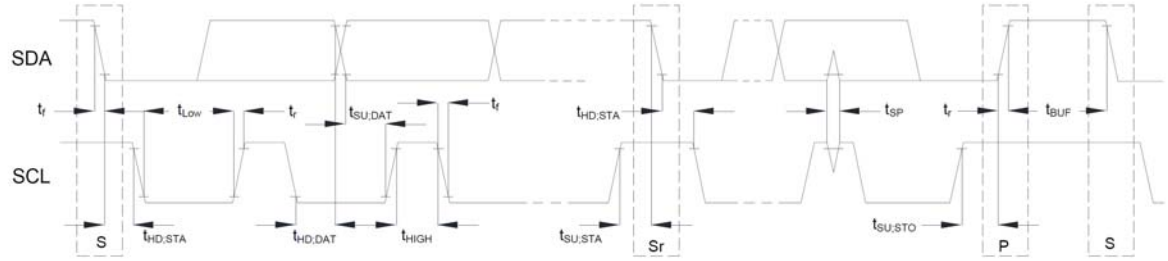
GND1, GND2 and GND3 should be connected together to have the same ground

10.3 Power- on Timing Chart (IIC interface)



Symbol	Parameter	MIN.	MAX.	Unit
$T_{Initial}$	After powering-on or resetting the device, the device needs I_{nitial} time to configure the system.	-	100	ms
T_{Reset}	/Reset pin low hold time	50	-	μs

10.4 IIC AC Waveform



10.5 IIC Characteristics

Symbol	Parameter	100KHz			400KHz		
		Min	Max	Unit	Min	Max	Unit
f_{SCL}	SCL clock frequency	0	100	kHz	0	400	KHz
$t_{HD;STA}$	Hold time (repeated) START condition. After this period, the first clock pulse is generated	4.0	–	µs	0.6	–	µs
t_{LOW}	LOW period of the SCL clock	4.7	–	µs	1.3	–	µs
t_{HIGH}	HIGH period of the SCL clock	4.0	–	µs	0.6	–	µs
$t_{SU;STA}$	Set-up time for a repeated START condition	4.7	–	µs	0.6	–	µs
$t_{HD;DAT}$	Data hold time	0	3.45	µs	0	0.9	µs
$t_{SU;DAT}$	Data set-up time	250	–	ns	100	–	ns
t_r	Rise time of both SDA and SCL signals	–	1000	ns	–	300	ns
t_f	Fall time of both SDA and SCL signals	–	300	ns	–	300	ns
$t_{SU;STO}$	Set-up time for STOP condition	4.0	–	µs	0.6	–	µs
t_{BUF}	Bus free time between a STOP and START condition	4.7	–	µs	1.3	–	µs

10.6 Format Protocol

Protocol V3.X Command List

CMD Code	Name	Set /Get	Note	b7	b6	b5	b4	b3	b2	b1	b0
0x10	Touch Information	Get		0: No touch 1: Last Report at ID 0 to ID 5 (include release status) 2: Last Report at ID 6 to ID 9 (include release status)							
			ID0	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID1	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID2	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID3	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID4	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							

			ID5	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
0x14	Touch Information 2	Get	ID6	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
			ID7	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
			ID8	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
			ID9	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
0x20				The maximum X coordinate (bit 7:0)		
				The maximum X coordinate (bit 15:8)		
				The maximum Y coordinate (bit 7:0)		
				The maximum Y coordinate (bit 15:8)		
				The channel numbers of X direction		
				The channel numbers of Y direction		
				The maximum report points		

				The channel numbers of TouchKey / Scrolling Bar
				For Touch Key Application (Maximum supports 31 Touch Key) Byte 8 : The Touch Key number (<32) Byte 9: 0xFF
0x30	Enter Sleep Mode	Set		--
0x40	Firmware Version	Get		Chip ID Code
				Major firmware version
				Minor firmware version
				Release firmware version
				For Customer Firmware Version
				For Customer Firmware Version
				For Customer Firmware Version
				For Customer Firmware Version
0x42		Get		Major protocol version : 0x03
				Minor protocol version : XX
				Release protocol version : XX

Protocol V3.X Data Format

CMD Code	Name	Set / Get	Note	b7	b6	b5	b4	b3	b2	b1	b0
0x10	Touch Information	Get	Packet Number	0: No touch 1: Last Report at ID 0 to ID 5 (include release status) 2: Last Report at ID 6 to ID 9 (include release status)							
			ID0	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID1	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID2	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID3	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction coordinate							
				0	0	Y_High direction coordinate					
				Y_Low direction coordinate							
				Touch Pressure							
			ID4	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					

				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		
			ID5	1: Touch Down, 0: Touch Off	0	X_High direction coordinate
				X_Low direction coordinate		
				0	0	Y_High direction coordinate
				Y_Low direction coordinate		
				Touch Pressure		

10.7 Interrupt Pin (INT) Control

When a finger touches on the sensor surface, the INT pin will be pull low. TP controller supports two different type control method.

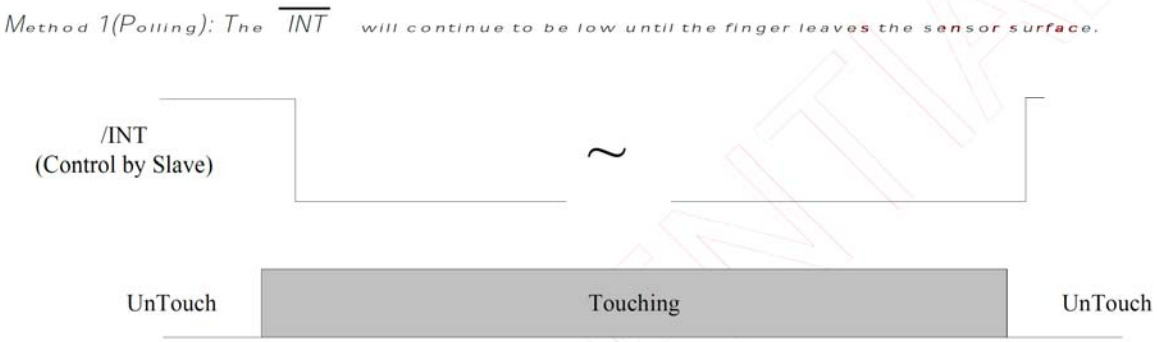


Fig 9: Method 1: $\overline{INT}$ Pin Control Diagram (Finger Touch)

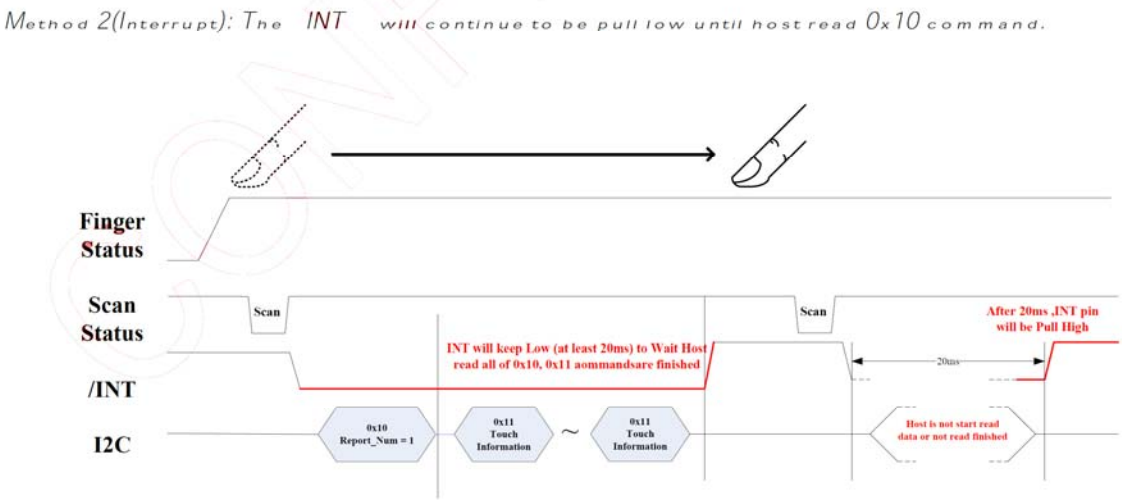


Fig 10: Method 2: $\overline{INT}$ Pin Control Diagram (Finger Touch)

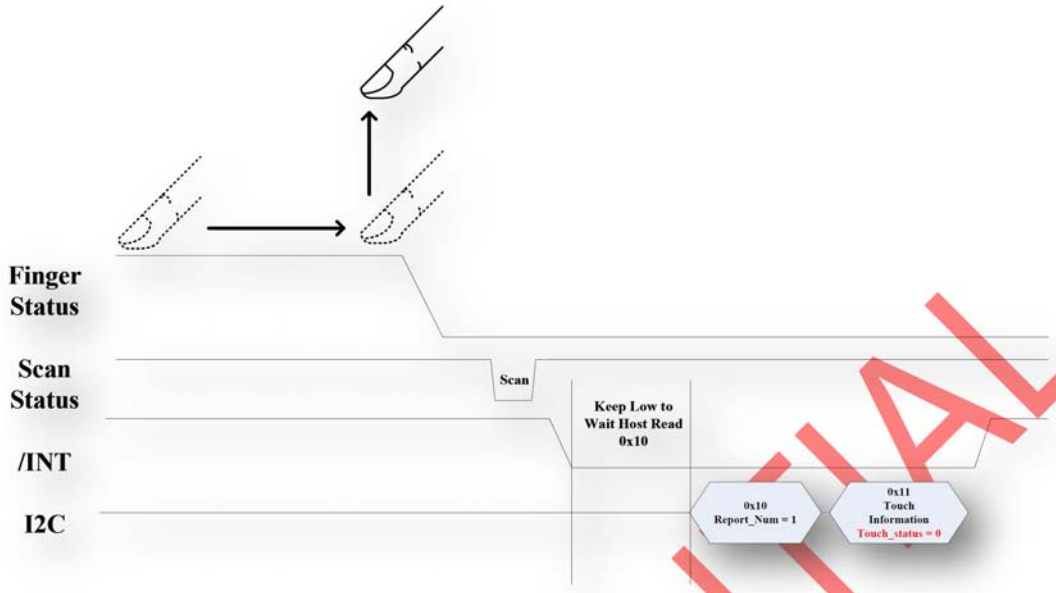


Fig 11: Method 2: $\overline{\text{INT}}$ Pin Control Diagram (Finger Release)

10.8 Device Address

MSB							LSB
1	0	0	0	0	0	1	0/1
Device Address							R/W

7-bit Device Address: 0x41

8-bit Device Read Address:0x83

8-bit Device Write Address:0x82

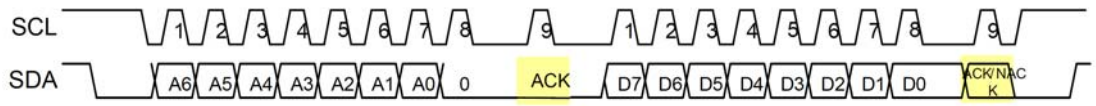
10.9 Data Transfer

Data is transferred over the IIC bus with 8-bit address and 8-bit data.

1	7	1	1	8	1	1
S	Slave Address	Wr	A	Data Byte	A	P

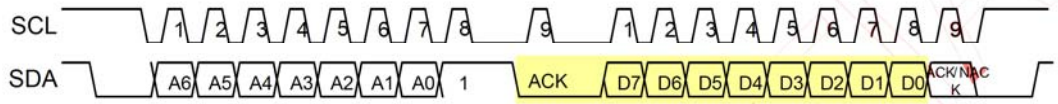
S	Start Condition
Sr	Repeated Start Condition
Rd	Read (bit value of 1)
Wr	Write (bit value of 0)
A/NA	Acknowledge (this bit position may be '0' for an ACK or '1' for a NACK)
P	Stop Condition
	Master-to-Slave
	Slave-to-Master
---	Continue

I2C Write timing



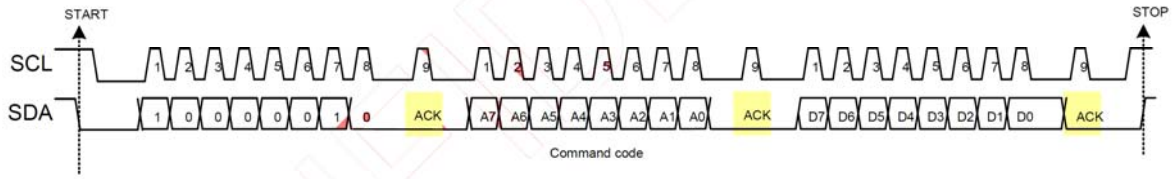
=> slave to master

I2C Read timing



=> slave to master

Byte Write



S	Slave Address	Wr	A	Command Code	A	Data Byte	A	P

F Byte Write

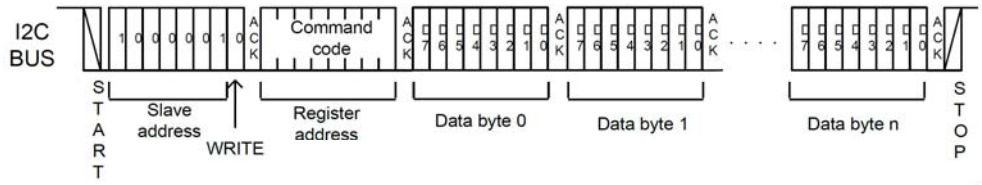
Byte Read

c

S	Slave Address	Wr	A	Command Code	A	Sr	Slave Address	Rd	A	Data Byte	A	P

F Byte Read

Multi-Byte Write

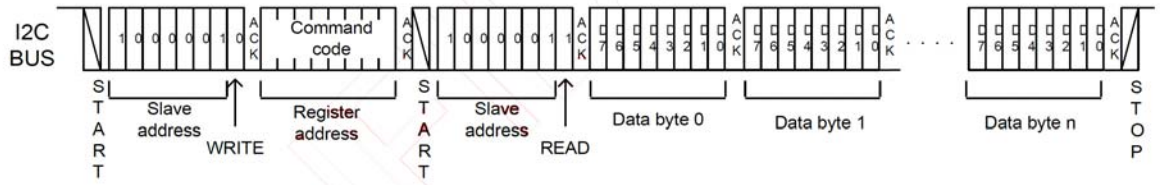


S	Slave Address	Wr	A	Command Code	A	Data Byte 0	A	Data Byte 1	A

Data Byte 2	A	-----	A	Data Byte N	A	P

F Multi-Byte Write

Multi-Byte Read



S	Slave Address	Wr	A	Command Code	A	Sr	Slave Address	Rd	A	Data Byte 0	A

Data Byte 1	A	-----	A	Data Byte N	NA	P

F Multi-Byte Read

11.0 RELIABILITY TEST CONDITIONS

Test Item	Test Conditions	Note
High Temperature Operation	70±3°C ,Dry t=240 hrs	
Low Temperature Operation	-20±3°C, Dry t=240 hrs	
High Temperature Storage	80±3°C , Dry t=240 hrs	1,2
Low Temperature Storage	-30±3°C ,Dry t=240 hrs	1,2
Thermal Shock Test	-20°C ~ 25°C ~ 70°C 30 m in. 5 min. 30 min. (1 cycle) Total 100 cycle(Dry)	1,2
Storage Humidity Test	60 °C, Humidity 90%, 240 hrs	1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).

Note 3 : The module shouldn't be tested more than one condition, and all the test conditions are independent.

Note 4 : All the reliability tests should be done without protective film on the module.

Definitions of life end point:

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

12.0 USE PRECAUTIONS

12.1 Handling precautions

1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

12.2 Installing precautions

1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. 1MΩ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

12.3 Storage precautions

1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

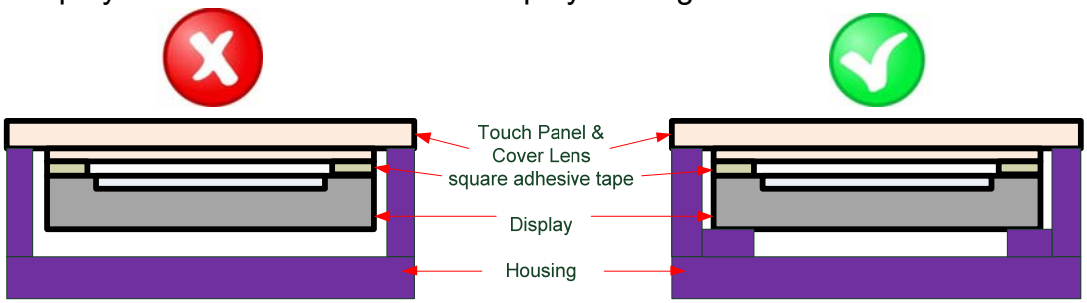
12.4 Operating precautions

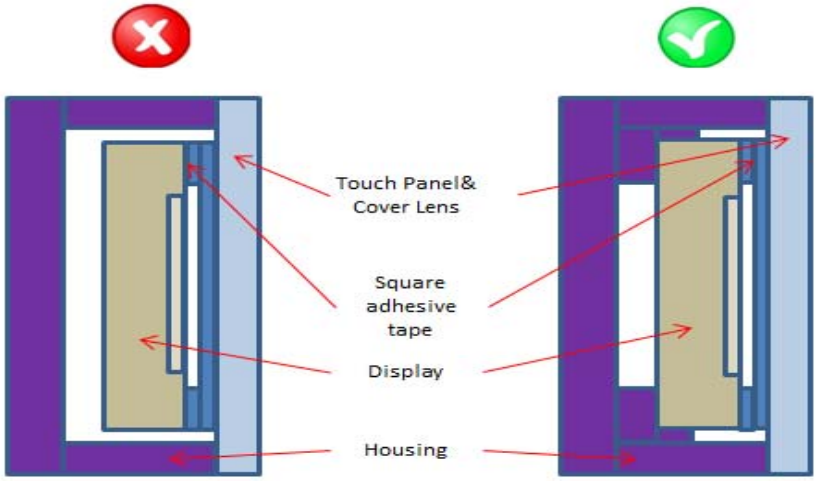
1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.

8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

12.5 Mechanism

(1) Please mount LCD module by using mounting holes arranged in four corners tightly.
(2) The square adhesive tape which is between the touch panel and display can't provide well supporting in the long term and high ambient temperature condition. Whether upright or horizontal position the support holder which is in the back side of the display is needed. Do not let the display floating.

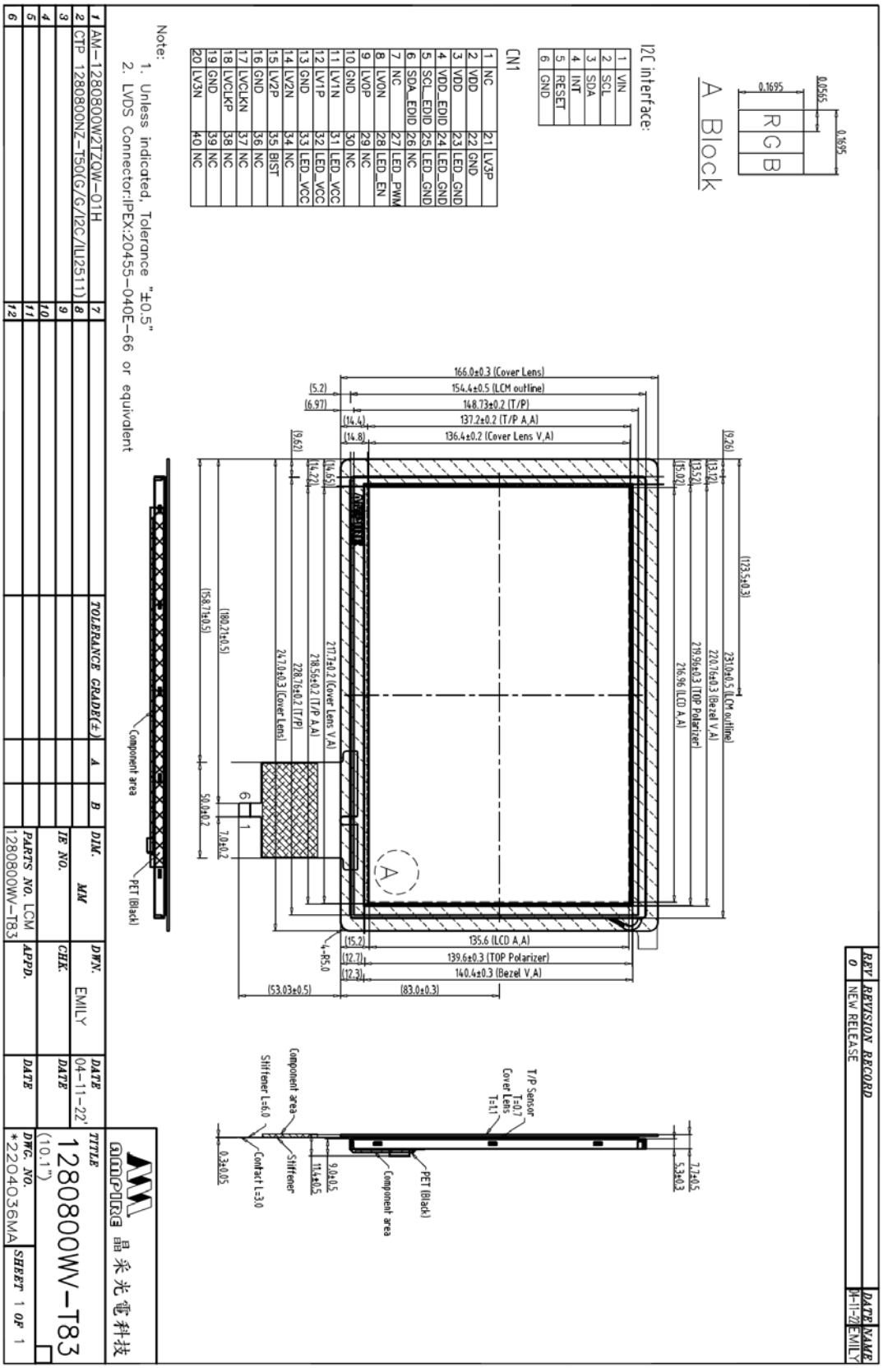


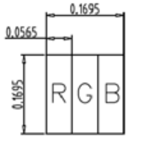


12.6 Other

1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
2) Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver.
3) AMIPRE will provide one year warrantee for all products and three months warrantee for all repairing products.

13.0 MECHANIC DRAWING





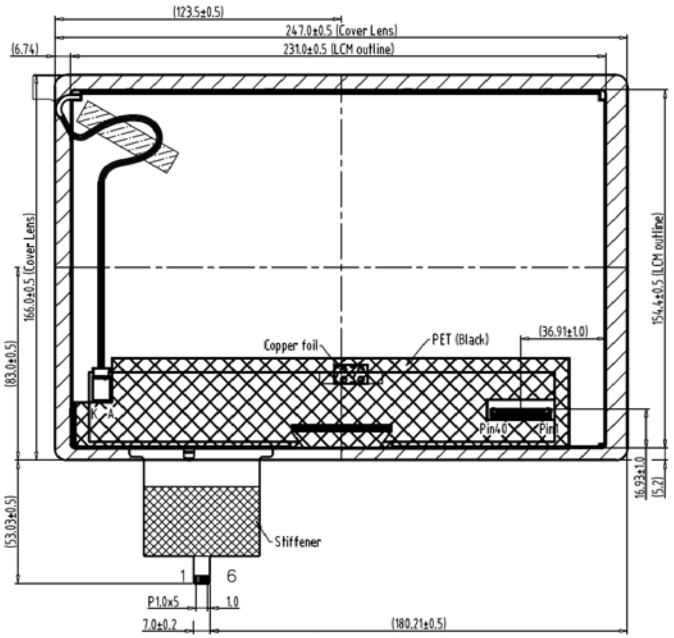
A Block

I2C interface:

1	VIN
2	SCL
3	SDA
4	INT
5	RESET
6	GND

CN1

1	NC	21	LV3P
2	VDD	22	GND
3	VDD	23	LED_GND
4	VDD_EDID	24	LED_GND
5	SCL_EDID	25	LED_GND
6	SDA_EDID	26	NC
7	NC	27	LED_PWM
8	LVON	28	LED_EN
9	LVOP	29	NC
10	GND	30	NC
11	LV1N	31	LED_VCC
12	LV1P	32	LED_VCC
13	GND	33	LED_VCC
14	LV2N	34	NC
15	LV2P	35	BIST
16	GND	36	NC
17	LVCLKN	37	NC
18	LVCLKP	38	NC
19	GND	39	NC
20	LV3N	40	NC



Back view

Note:
1. Unless indicated, Tolerance "±0.5"
2. LVDS Connector:IPEX:20455-040E-66 or equivalent

				TOLERANCE GRADE(±)	A	B
1	AM-1280800W2TZQW-01H	7				
2	CTP 1280800NZ-T50(G/G/I2C/ILI2511)	8				
3		9				
4		10				
5		11				
6		12				

AMPIRE 晶采光電科技

DIM. MM	DWN. EMILY	DATE 04-11-22'	TITLE 1280800WV-T83 (10.1")
IE NO.	CHK.	DATE	
PARTS NO. LCM-1 1280800WV-T83	APPD.	DATE	DWG. NO. *2204037MA / SHEET 1 OF 1